# AN8470NSA

# Spindle motor driver IC for optical disk

#### Overview

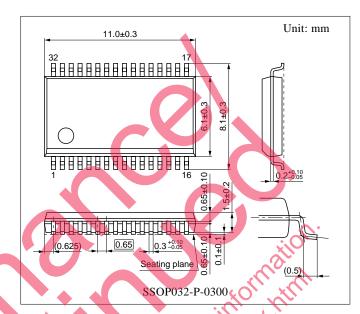
The AN8470NSA is a high performance IC suited for driving a spindle motor of an optical disk such as CD-ROM, PD, DVD, CD-R, CD-RW, etc.

#### ■ Features

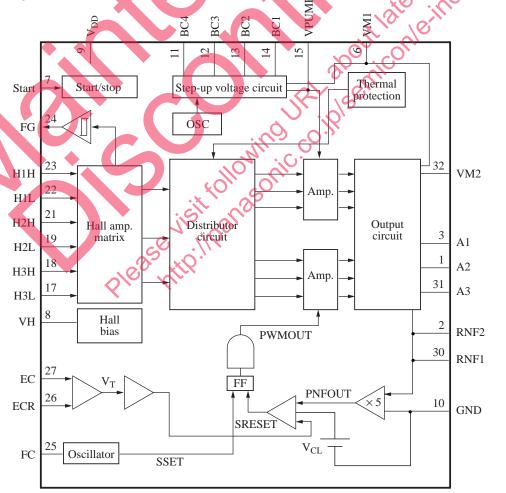
- Low power consumption due to a direct PWM system
- With start and stop pin
- Reverse breaking by EC/ECR voltage
- With Hall bias pin
- Surface-mount small package

#### Applications

• High speed CD-ROM drive PD, DVD, CD-R, CD-RW drives



### ■ Block Diagram



#### ■ Pin Descriptions

Pin No.	Symbol	Description	Pin No.	Symbol	Description
1	A2	Drive output 2	17	H3L	Hall element-3 negative input pin
2	RNF2	Current det. pin 2	18	НЗН	Hall element-3 positive input pin
3	A1	Drive output 1	19	H2L	Hall element-2 negative input pin
4	N.C.	N.C.	20	N.C.	N.C.
5	N.C.	N.C.	21	Н2Н	Hall element-2 positive input pin
6	VM1	Motor supply voltage pin 1	22	H1L	Hall element-1 negative input pin
7	Start	Start/stop changeover pin	23	НІН	Hall element-1 positive input pin
8	VH	Hall bias pin	24	FG	FG signal output pin
9	$V_{\mathrm{DD}}$	Supply voltage pin	25	FC	Oscillator pin
10	GND	Ground pin	26	ECR	Torque command reference input pin
11	BC4	Booster capacitor connection pin 4	27	EC	Torque command input pin
12	BC3	Booster capacitor connection pin 3	28	N.C.	N.C.
13	BC2	Booster capacitor connection pin 2	29	N.C.	N.C.
14	BC1	Booster capacitor connection pin 1	30	RNF1	Current det. pin 1
15	VPUMP	Booster pin	31	A3	Drive output 3
16	N.C.	N.C.	32	VM2	Motor supply voltage pin 2

### ■ Absolute Maximum Ratings

Parameter	Symbol	Rating	Unit
Supply voltage *2	$V_{DD}$	6.0	V
	$V_{M1}$	JI ;0 3	
	$V_{M2}$	"" (O CO.)"	
Drive output voltage *5	$V_{(m)}$	15.0	V
Control signal input voltage *6	V <sub>(n)</sub>	0 to V <sub>DD</sub>	V
Supply current	$I_{DD}$	30.0	mA
Drive output current *4	I <sub>(0)</sub>	±1 200	mA
Hall bias current	I <sub>HB</sub>	30.0	mA
Power dissipation *3	$P_{\mathrm{D}}$	293	mW
Operating ambient temperature *1	$T_{opr}$	-20 to +70	°C
Storage temperature *1	T <sub>stg</sub>	-55 to +150	°C

Note) Do not apply external currents or voltages to any pins not specifically mentioned.

For circuit currents, '+' denotes current flowing into the IC, and '-' denotes current flowing out of the IC.

- \*1: Except for the operating ambient temperature and storage temperature, all ratings are for  $T_a = 25^{\circ}$ C.
- \*2: The voltage in the step-up voltage circuit exceeds the supply voltage.

  For the allowable value of the step-up voltage, refer to "■ Electrical Characteristics".
- \*3: For 70°C and IC alone.
- \*4: o = 1, 2, 3, 6, 30, 31, 32
- \*5: m = 1, 3, 31
- \*6: n = 7, 17, 18, 19, 21, 22, 23, 26, 27

# ■ Recommended Operating Range

Parameter	Symbol	Range	Unit
Supply voltage	$V_{DD}$	4.5 to 5.5	V
	$V_{M1}$		
	V <sub>M2</sub>		

# ■ Electrical Characteristics at $T_a = 25$ °C

Parameter	Symbol	Conditions	Min	Тур	Max	Unit
Overall						
Circuit current 1	$I_{\mathrm{DD1}}$	$V_{DD} = 5 \text{ V in power save mode}$	_	0	0.1	mA
Circuit current 2	$I_{\mathrm{DD2}}$	$V_{DD} = 5 \text{ V}$		9	14	mA
Start/stop						•
Start voltage	V <sub>START</sub>	Voltage with which a circuit operates at $V_{DD} = 5~V$ and $L \rightarrow H$	2.7			·V
Stop voltage	V <sub>STOP</sub>	Voltage with which a circuit becomes off at $V_{DD} = 5 \text{ V}$ and $H \rightarrow L$	产	, OIT	0.7	V
Hall bias				101	r'i	
Hall bias voltage	$V_{HB}$	$V_{DD} = 5 \text{ V}, I_{HB} = 20 \text{ mA}$	0.7	Po	1.6	V
Hall amplifier				111		
Input bias current	$I_{BH}$	$V_{DD} = 5 \text{ V}$	4	1	5	μΑ
In-phase input voltage range	V <sub>HBR</sub>	$V_{DD} = 5 \text{ V}$ , except for H2H, H2L	1.5		4.0	V
Minimum input level	V <sub>INH</sub>	$V_{DD} = 5 \text{ V}$	60			mV[p-p]
Torque command		11:115				
In-phase input voltage range	EC	$V_{DD} = 5 \text{ V}$	0.5		3.9	V
Offset voltage	EC <sub>OF</sub>	$V_{DD} = 5 \text{ W}$	-100	0	100	mV
Dead zone	$EC_{DZ}$	$V_{DB} = 5 \text{ V}$	0	75	150	mV
Input current	EC <sub>IN</sub>	$V_{DD} = 5 \text{ V}, EC = ECR = 2.5 \text{ V}$	<b>-</b> 5	-1	_	μΑ
Input/output gain	A <sub>GS</sub>	$V_{DD} = 5 \text{ V}, R_{CS} = 0.33 \Omega$	0.36	0.48	0.60	A/V
Output	50					
High-level output saturation voltage	$V_{OH}$	$V_{DD} = 5 \text{ V}, I_{O} = -500 \text{ mA}$		0.25	0.50	V
Low-level output saturation voltage	V <sub>OL</sub>	$V_{DD} = 5 \text{ V}, I_{O} = 500 \text{ mA}$		0.25	0.50	V
Torque limit current	$I_{TL}$	$V_{DD} = 5 \text{ V}, R_{CS} = 0.33 \Omega$	455	570	685	mA
OSC						
Charging current	$I_{CH}$	$V_{DD} = 5 \text{ V}$	-65	-50	-35	μΑ
Upper threshold voltage	V <sub>CH</sub>	$V_{DD} = 5 \text{ V}$	1.75	2.50	3.25	V
Lower threshold voltage	V <sub>CL</sub>	$V_{DD} = 5 \text{ V}$	0.35	0.50	0.65	V

# ■ Electrical Characteristics at $T_a = 25$ °C (continued)

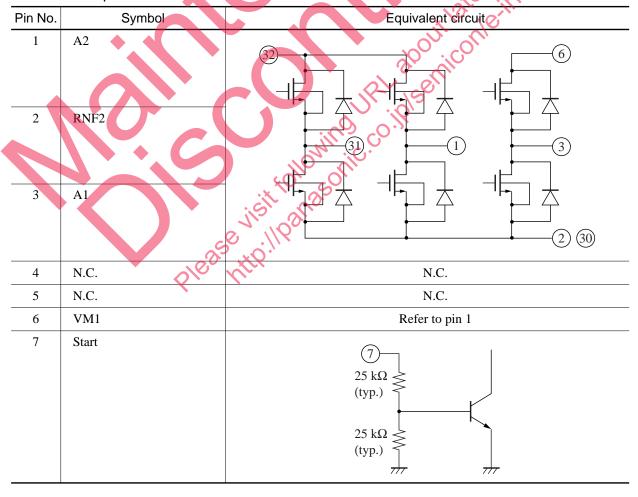
Parameter	Symbol	Conditions	Min	Тур	Max	Unit	
FG							
FG output high-level	FG <sub>H</sub>	$V_{DD} = 5 \text{ V}, I_{FG} = -0.01 \text{ mA}$	3		_	V	
FG output low-level	FG <sub>L</sub>	$V_{DD} = 5 \text{ V}, I_{FG} = 0.01 \text{ mA}$	_	_	0.5	V	
In-phase input voltage range	V <sub>FGR</sub>	$V_{DD} = 5 \text{ V}$	1.5		3.0	V	
FG hysteresis width	$H_{FG}$	$V_{DD} = 5 \text{ V}$	5	10	20	mV	
Step-up circuit							
Step-up voltage	V <sub>PUMP</sub>	$V_{DD} = 5 \text{ V}, V_{M1} = V_{M2} = 5 \text{ V}$	9.5		15	V	

#### • Design reference data

Note) The characteristics listed below are theoretical values based on the IC design and are not guaranteed.

Parameter	Symbol	Conditions	Min	Тур	Max	Unit
Thermal protection			K			/.
Thermal protection operating temperature	T <sub>SDON</sub>	$V_{DD} = 5 \text{ V}$	<b>)</b>	170	Silo	°C
Thermal protection hysteresis width	$\Delta T_{SD}$	$V_{DD} = 5 \text{ V}$	_	(45)	14C	°C

### ■ Terminal Equivalent Circuits



# ■ Terminal Equivalent Circuits (continued)

8 VH 9 V <sub>DD</sub>	8
	Supply voltage pin
10 GND	Ground pin
11 BC4  12 BC3	
13 BC2	The strike that the strike the st
14 BC1	Your Property of the second of
15 VPUMP	JR! plsemie
16 N.C.	, no co.11 N.C.
17 H3L	N.C.  N.C.  N.C.  N.C.  N.C.  N.C. $2 k\Omega$
18 H3H	$\begin{array}{cccccccccccccccccccccccccccccccccccc$
19 H2L	$ \begin{array}{c c} 21 & & & \\ 2 & k\Omega \\ (typ.) & & \\ \end{array} $
20 N.C.	N.C.

# ■ Terminal Equivalent Circuits (continued)

Pin No.	Symbol	Equivalent circuit
21	Н2Н	Refer to pin 19
22	H1L	Refer to pin 17
23	H1H	Refer to pin 17
24	FG	$V_{DD}$ $\stackrel{>}{\lessgtr} 50 \text{ k}\Omega$ $\stackrel{>}{\lessgtr} (typ.)$
25	FC	$V_{DD}$ $1 \text{ k}\Omega$ $(\text{typ.})$ $(\text{typ.})$ $(\text{typ.})$
26	ECR	V <sub>DD</sub> altonico
27	EC	
		$\begin{array}{cccccccccccccccccccccccccccccccccccc$
28	N.C.	N.C.
29	N.C.	N.C.
30	RNF1	Refer to pin 1
31	A3	Refer to pin 1
32	VM2	Refer to pin 1

### ■ Usage Notes

• Prevent this IC from being line-to-ground fault.

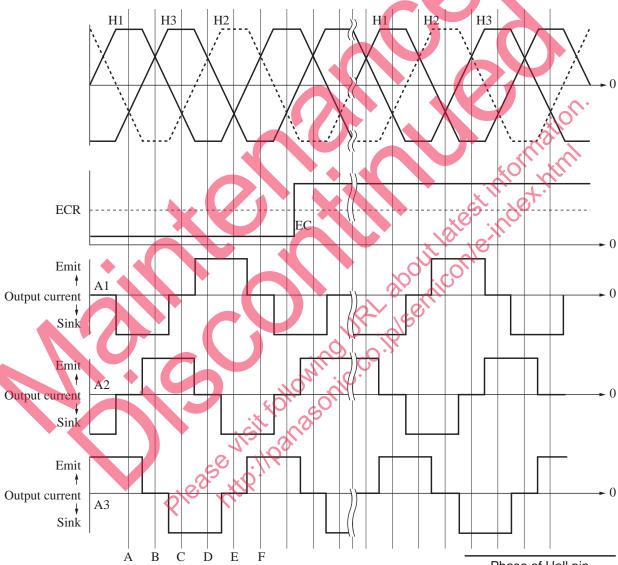
(To be concrete, do not short-circuit any of A1 (pin 3), A2 (pin 1) and A3 (pin 31) with GND pin (pin 10).)

• Be careful of the following three pins because their static breakdown voltages are low. (C = 200 pF, R = 0  $\Omega$ )

Pin 11: breakdown at 80 V Pin 14: breakdown at 90 V Pin 24: breakdown at 190 V

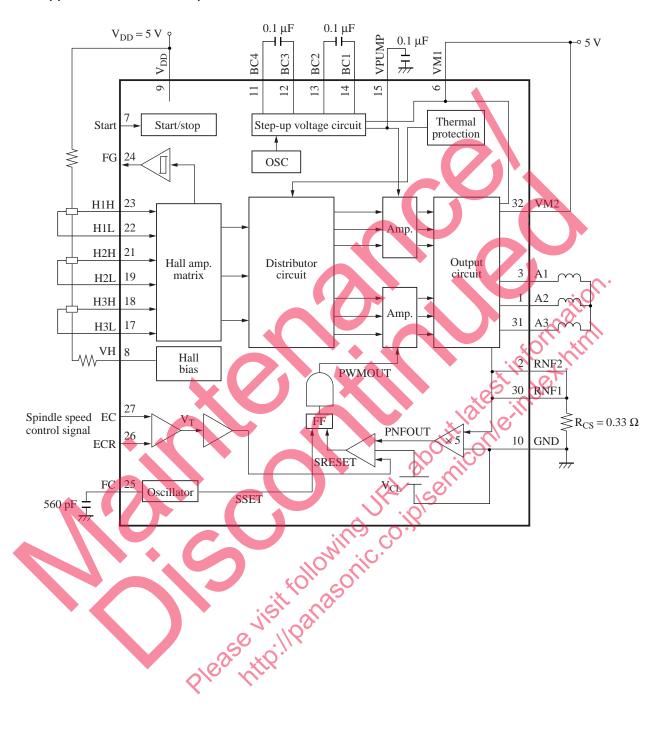
### ■ Application Note

• Phase conditions between Hall input and output current



Phase of Hall pin H1H H2H НЗН Η MLMLΑ В MH L MHMLMLΗ L MH MH D Е MLΗ MLF MH MH L

#### ■ Application Circuit Example



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